

100 V, 1 A low leakage current Schottky barrier rectifier 7 May 2015 **Product data sheet**

1. **General description**

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD123W small and flat lead Surface-Mounted Device (SMD) plastic package.

Features and benefits 2.

- Average forward current: $I_{F(AV)} \le 1 A$ •
- Reverse voltage: V_R ≤ 100 V •
- Low forward voltage: V_F = 710 mV
- High power capability due to clip-bonding technology
- Extremely low leakage current I_R = 40 nA •
- High temperature $T_i \le 175 \text{ °C}$ •
- AEC-Q101 gualified

Applications 3.

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection
- Low power consumption applications

Quick reference data 4.

Table 1. Qui	ck reference data					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; T _{sp} ≤ 170 °C; square wave	-	-	1	A
V _R	reverse voltage	T _j = 25 °C	-	-	100	V
V _F	forward voltage	I_F = 1 A; $t_p \le 300$ μs; δ ≤ 0.02 ; T_j = 25 °C	-	710	770	mV
I _R	reverse current	V_R = 100 V; $t_p \le 300 \ \mu$ s; $\delta \le 0.02$; T _j = 25 °C	-	40	150	nA





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5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	к	cathode[1]		1 🛃 2
2	A	anode	SOD123W	sym001

[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information							
Type number Package							
	Name	Description	Version				
PMEG10010ELR	SOD123W	plastic surface mounted package; 2 leads	SOD123W				

7. Marking

Table 4. Marking codes	
Type number	Marking code
PMEG10010ELR	К7

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	100	V
I _F	forward current	T _{sp} = 165 °C; δ = 1		-	1.4	А
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; T _{amb} ≤ 135 °C; square wave	[1]	-	1	A
		δ = 0.5; f = 20 kHz; T _{sp} ≤ 170 °C; square wave		-	1	A
I _{FSM}	non-repetitive peak forward current	t_p = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	50	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	680	mW
			[3]	-	1150	mW
			[1]	-	2140	mW
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

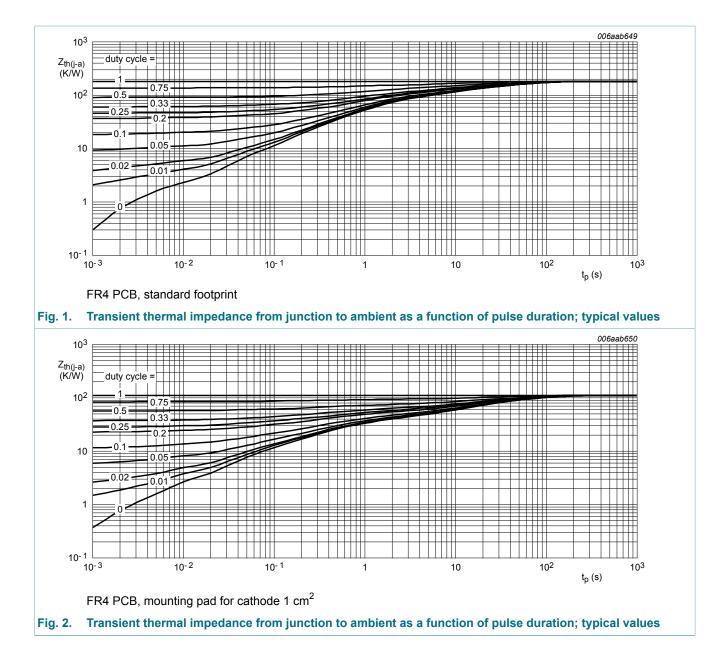
Table 6. T	hermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ui(j-a)	thermal resistance	in free air	[1][2]	-	-	220	K/W
	from junction to		[1][3]	-	-	130	K/W
	ampient		[1][4]	-	-	70	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[5]	-	-	18	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- ^[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Device mounted on a ceramic PCB, AI_2O_3 , standard footprint.
- [5] Soldering point of cathode tab.

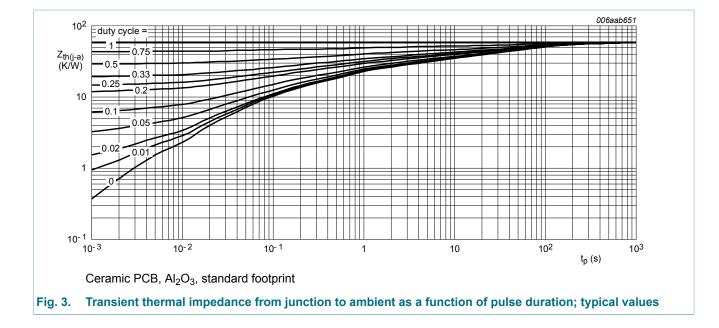
PMEG10010ELR

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PMEG10010ELR

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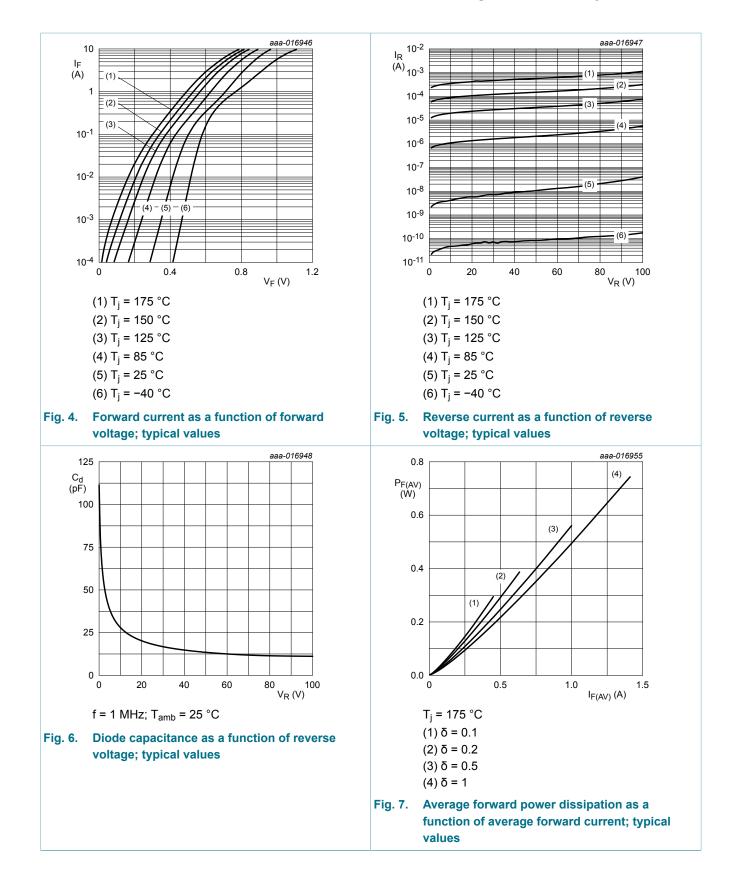
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10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{(BR)R}	reverse breakdown voltage	I _R = 1 mA; T _j = 25 °C; t _p = 300 μs; $\overline{\delta}$ = 0.02	100	-	-	V
V _F	forward voltage	$I_F = 0.1 \text{ A}; t_p \le 300 \text{ μs}; \delta \le 0.02;$ $T_j = 25 \text{ °C}$	-	505	565	mV
		I _F = 0.5 A; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	640	710	mV
	$I_F = 0.7$ A; $t_p \le 300$ μs; δ ≤ 0.02 ; $T_j = 25$ °C	-	675	740	mV	
		$I_{\text{F}} = 1 \text{ A}; t_{\text{p}} \leq 300 \mu\text{s}; \delta \leq 0.02;$ $T_{\text{j}} = 25 ^{\circ}\text{C}$	-	710	770	mV
		I_F = 1 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 125 °C	-	575	680	mV
I _R rev	reverse current	V_R = 10 V; $t_p \le 300 \ \mu s$; $\delta \le 0.02$; T_j = 25 °C	-	4	-	nA
		V_R = 60 V; $t_p \le 300 \ \mu s$; $\delta \le 0.02$; T_j = 25 °C	-	12	-	nA
		V_R = 100 V; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	40	150	nA
		V_R = 100 V; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 125 °C	-	70	500	μA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	70	-	pF
		V _R = 4 V; f = 1 MHz; T _j = 25 °C	-	42	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C	-	28	-	pF
rr	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 1 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_j = 25 \text{ °C}$	-	3.7	-	ns
V _{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; \text{ d}I_F/\text{d}t = 20 \text{ A}/\mu\text{s}; T_j = 25 ^\circ\text{C}$	-	690	-	V

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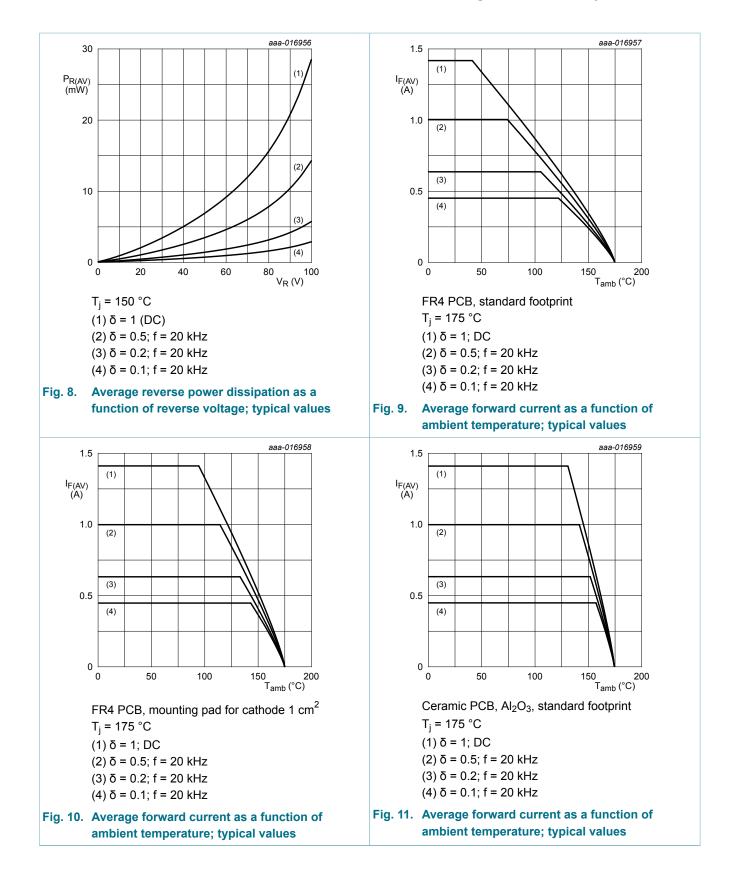
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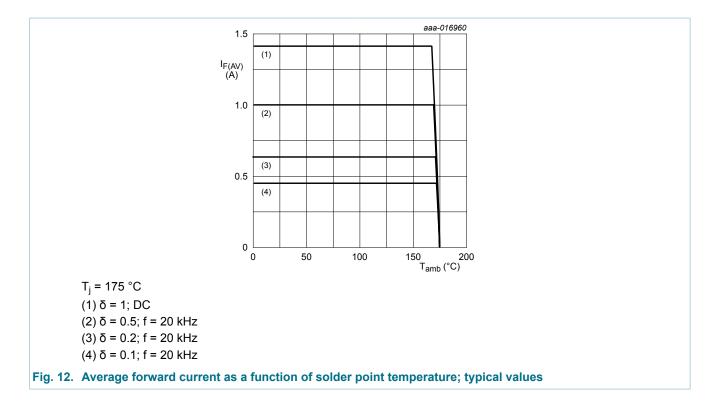
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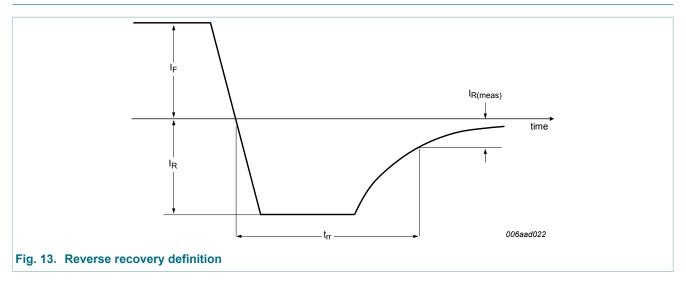


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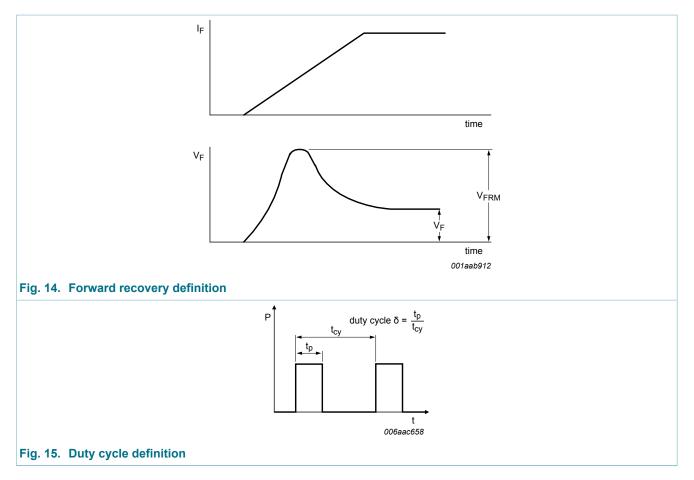


11. Test information



PMEG10010ELR

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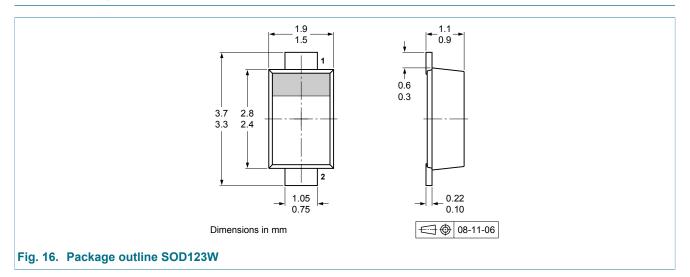
The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

11.1 Quality information

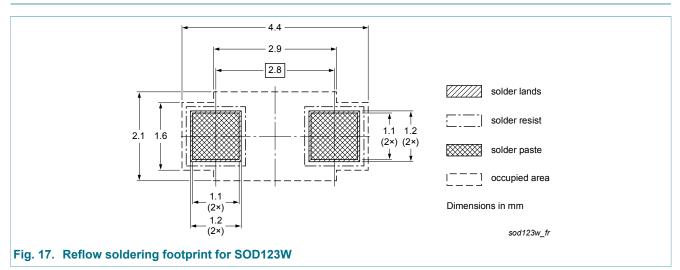
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

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12. Package outline



13. Soldering



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14. Revision history

Table 8. Revision his	story					
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PMEG10010ELR v.2	20150507	Product data sheet	-	PMEG10010ELR v.1		
Modifications:	Modifications: • Product status changed					
PMEG10010ELR v.1	20150220	Preliminary data sheet	-	-		

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15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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